SN54LS253, SN54S253, SN74LS253, SN74S253 DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS WITH 3-STATE OUTPUTS

SDLS147 - SEPTEMBER 1972 - REVISED MARCH 1988

- Three-State Version of SN54/74LS153, SN54/74S153
- Schottky-Diode-Clamped Transistors
- Permits Multiplexing from N Lines to 1 Line
- Performs Parallel-to Serial Conversion
- Fully Compatible with Most TTL Circuits
- Low Power Dissipation

'LS253 . . . 35 mW Typical 'S253 . . . 225 mW Typical

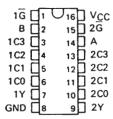
description

Each of these Schottky-clamped data selectors/multiplexers contains inverters and drivers to supply fully complementary, on-chip, binary decoding data selection to the AND-OR gates. Separate output control inputs are provided for each of the two four-line sections.

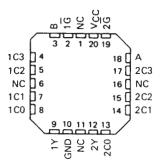
The three-state outputs can interface with and drive data lines of bus-organized systems. With all but one of the common outputs disabled (at a high-impedance state) the low-impedance of the single enabled output will drive the bus line to a high or low logic level.

SN54LS253, SN54S253 . . . J OR W PACKAGE SN74LS253, SN74S253 . . . D OR N PACKAGE

(TOP VIEW)



SN54LS253, SN54S253 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

FUNCTION TABLE

1	ECT UTS		DATA	INPUTS		OUTPUT CONTROL	ОUТРUТ
В	Α	CO	C1	C2	C3	G	Υ
X	X	X	X	X	X	Н	Z
L	L	L	X	X	Х	L	L
L	L	Н	X	X	X	L	н
L	н	×	L	X	X	L	L
L	H	×	Н	X	X	L	н
Н	Ĺ	×	X	L	X	L	L
н	L	×	X	Н	X	L	н
H	Н	×	X	X	L	L	L
Н	Н	X	×	X	Н	L	Н

Address inputs A and B are common to both sections.

H = high fevel, L = low level, X = irrelevant, Z = high impedance (off)

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

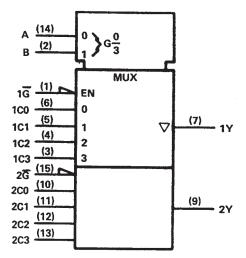
Supply voltage, VCC (see Note 1)	7 V
Input voltage: 'LS253	7 V
'S253	5.5 V
Off-state output voltage	
Operating free-air temperature range: SN54LS253, SN54S253 – 55°C to	125°C
SN74LS253, SN74S253	
Storage temperature range – 65°C to	150°C

NOTE 1: Voltage values are with respect to network ground terminal.

TEXAS INSTRUMENTS

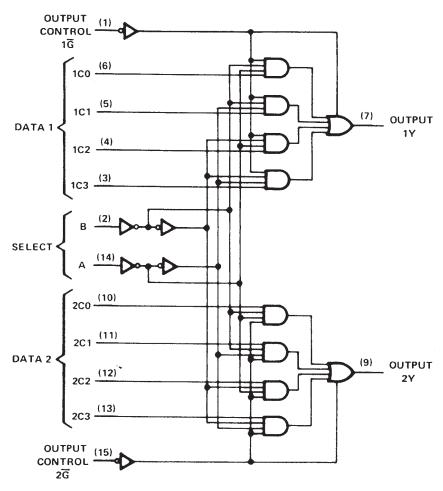
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logic symbol[†]



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

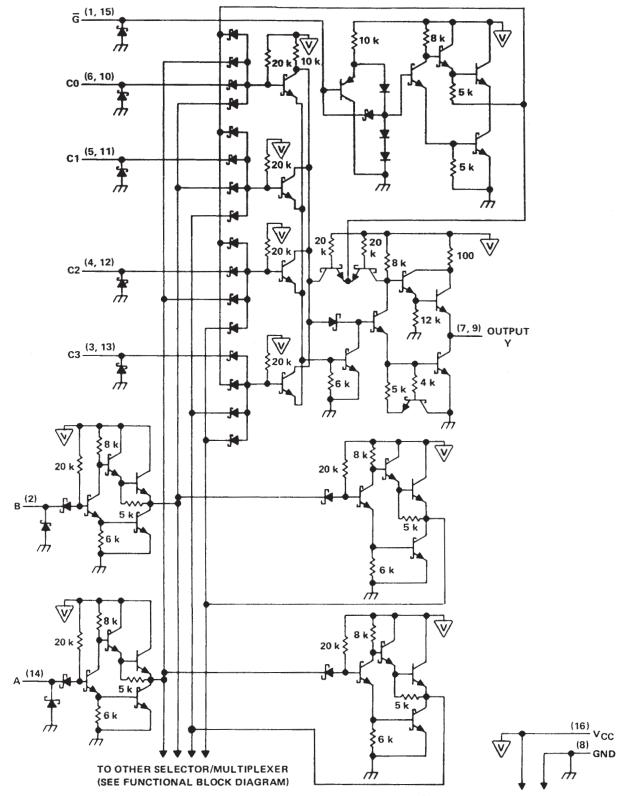
logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



schematic (each selector/multiplexer, and the common select section)



Pin numbers shown are for D, J, N, and W packages.



SN54LS253, SN54S253, SN74LS253, SN74S253 **DUAL 4-LINE TO 1-LINE DATA SELECTORS/MULTIPLEXERS** WITH 3-STATE OUTPUTS

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recommended operating conditions

		S	SN54LS253			SN74LS253		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
Іон	High-level output current			-1			2.6	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITI	onet		S	N54LS2	53	SN74LS253			
PANAMETEN		1521 CONDILL	ONS		MIN	TYP \$	MAX	MIN	TYP‡	MAX	UNIT
VIK	V _{CC} = MIN,	$I_1 = -18 \text{ mA}$					- 1.5			~ 1.5	V
VOH	V _{CC} = MIN,	V _{IH} = 2 V,	VIL = MAX,	1 _{OH} = MAX	2.4	3.4		2.4	3.1		٧
VOL VCC = N	Voc = MIN	V _{IH} = 2 V,	VIL = MAX	IOL = 4 mA		0.25	0.4		0.25	0.4	
	ACC - MIIA'			IOL = 8 mA					0.25	0.5	
loz V _{CC} = M	Voc = MAX	CC = MAX, VIH = 2 V		V _O = 2.7 V			20			20	
102	VCC - WAX,			V _O = 0.4 V			- 20			20	μΑ
11	V _{CC} = MAX,	V ₁ = 7 V					0.1			0.1	mΑ
IН	V _{CC} = MAX,	V ₁ = 2.7 V					20			20	μΑ
1	V _{CC} = MAX,	V. = 0.4.V		Ğ			- 0.2			- 0.2	
116	VCC - MAX,	, V _I = 0.4 V		All other	- 0.4					- 0.4	, mA
los§	V _{CC} = MAX				- 30		- 130	- 30		- 130	mΑ
loc	V _{CC} = MAX,	See Note 2		Condition A		7	12		7	12	
¹cc	VCC = WAA,	A CC - MAY' See Note 5		Condition B		8.5	14		8.5	14 mA	

[†] For conditions shown as MIN or MAX, use the appropriate value spcified under recommended operating conditions.

NOTE 2: I_{CC} is measured with the outputs open under the following conditions:

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT	
^t PLH	Data				17	25		
tPHL.	Data	'			13	20	ns	
^t PLH	Select		$C_L = 15 pF$, $R_L = 2 k\Omega$,		30	45		
^t PHL	Select	'	See Note 3		21	32	ns	
^t PZH	Output				15	28		
^t PZL	Control	'			15	23	ns	
^t PHZ	Output	_	$C_L = 5 pF$, $R_L = 2 k\Omega$,		27	41		
^t PLZ	Control	'	See Note 3		18	27	ns	

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.

[§] Not more than one output should be shorted at a time, and duration for the short-circuit should exceed one second.

A. All inputs grounded.

B. Output control at 4.5 V, all inputs grounded.

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recommended operating conditions

			SN54S253		SN74S253			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
ЮН	High-level output current			-2			- 6.5	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDIT	rionst		MIN	TYP‡	MAX	UNIT	
VIK	VCC = MIN,	I _I = - 18 mA						-1.2	V	
Voн	VCC = MIN,	V _{1H} = 2 V,	V _{1L} = 0.8 V,	IOH = MAX	Series 54S	2,5	3,4		V	
VOH	VCC Willy,	VIH - 2 V,		TOH - WIAX	Series 74S	2.7	3.4		1 °	
VOL	VCC = MIN,	VIH = 2 V,	VIL = 0.8 V,	IOL = 20 mA				0.5	V	
loz	Vcc = MAX,	MAX, VIH = 2 V			V _O = 2.4 V			50		
	VCC IMAX,	VIH - 2 V			V _O = 0.5 V			- 50	μΑ	
11	V _{CC} = MAX,	V1 = 5.5 V						1	mA	
ΊΗ	V _{CC} = MAX,	V _I = 2.7 V						50	μΑ	
111	Vcc = MAX,	VI = 0.5 V			G = 0.8 V			- 2		
7164	VCC - WAX,	V1 - 0.5 V			G = 2 V			- 0.25	mA	
los§	V _{CC} = MAX				1	- 40	••••	- 100	mA	
¹cc	V _{CC} = MAX,	See Note 2			Condition A		45	70		
	VCC = WAX,	C - MAX, See Note 2					65	85	mA	

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

Not more than one output should be shorted at a time and duration of short-circuit should not exceed one second,

NOTE 2: I_{CC} is measured with the outputs open under the following conditions:

- A. All inputs grounded.
- B. Output control at 4.5 V, all inputs grounded.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	DITIONS	MIN TYP	MAX	UNIT
^t PLH	Data	~			6	9	
^t PHL	Data	'	R _L = 280 Ω, See Note 3		6	9	ns
^t PLH	Select	v		C _L = 15 pF	11.5	18	
^t PHL]	'		o_ ,o p.	12	18	ns
^t PZH	Output				11	16.5	
^t PZL	Control	'			12	18	ns
^t PHZ	Output	_	R _L = 280 Ω,	C _L = 5 pF	6.5	9.5	
tPLZ	Control		See Note 3		10	15	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

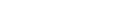


[‡] All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{C}$.



PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
76017012A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
7601701EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601701EA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
7601701FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
7601701FA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30908B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30908B2A	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30908BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30908BEA	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30908BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
JM38510/30908BFA	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS253J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN54LS253J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SN74LS253D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS253J	OBSOLETE	CDIP	J	16		TBD	Call TI	Call TI
SN74LS253N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS253N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS253N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS253N3	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74LS253NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS253NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
SN74LS253NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS253NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM



PACKAGE OPTION ADDENDUM

26-Sep-2005

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
						no Sb/Br)		
SN74LS253NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S253N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SN74S253N	OBSOLETE	PDIP	N	16		TBD	Call TI	Call TI
SNJ54LS253FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS253FK	ACTIVE	LCCC	FK	20	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS253J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS253J	ACTIVE	CDIP	J	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS253W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC
SNJ54LS253W	ACTIVE	CFP	W	16	1	TBD	Call TI	Level-NC-NC-NC

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC



FK (S-CQCC-N**)

28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN

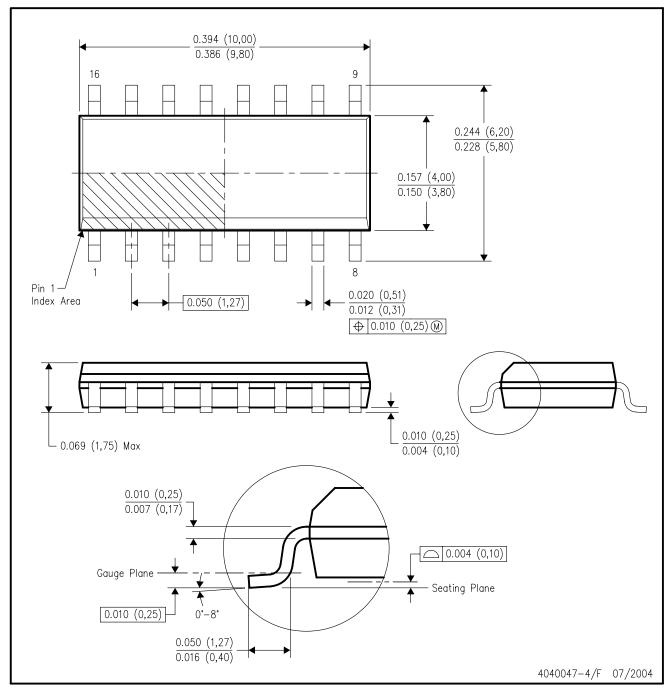


- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G16)

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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